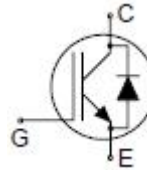


PRELIMINARY DATASHEET
IGBT with soft, fast recovery anti-parallel diode, in EXT TO264 Package

- Ultra low loss IGBT
- Highly rugged SPT design
- Designed for
 - Motor controls
 - General inverters
 - Uninterrupted power supplies (UPS)
- Pb-free finished; RoHS compliant


MAXIMUM RATINGS, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value	Units
Collector-emitter voltage	V_{CES}	1200	V
DC collector current, $T_c = 100^\circ\text{C}$	I_C	57	A
Peak collector current	I_{CM}	114	
Diode forward current	I_F	50	
Diode peak forward current	I_{FM}	100	
Gate-emitter voltage	V_{GE}	± 20	V
IGBT short circuit SOA $V_{CC} = 1200\text{V}$, $V_{GE} = 15\text{V}$, $V_{CEM} \leq 1200\text{V}$, $T_{vj} \leq 125^\circ\text{C}$	t_{SC}	10	μs
Operating junction and storage temperature	T_j, T_{stg}	-40... +150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max. Value	Units
Characteristics			
IGBT thermal resistance, junction to case	R_{thJC}	0.33	K/W
Diode thermal resistance, junction to case	R_{thJD}	0.65	
Thermal resistance, junction to ambient	R_{thJA}	40	

ELECTRICAL CHARACTERISTICS, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Characteristics						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0\text{V}$, $I_C = 1\text{mA}$	1200	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE} = 15\text{V}$, $I_C = 57\text{A}$	1.7	1.87	2.0	
Diode forward voltage	V_F	$V_{GE} = 0\text{V}$, $I_F = 50\text{A}$	-	1.8	-	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C = 2\text{mA}$, $V_{CE} = V_{GE}$	5	-	7	
Zero gate voltage collector current	I_{CES}	$V_{CE} = 1200\text{V}$, $V_{GE} = 0$ $T = 25^\circ\text{C}$	-	-	100	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{V}$, $V_{GE} = \pm 20\text{V}$	-200	-	200	nA
Internal gate resistance	R_{Gint}		-	10	-	Ω
Dynamic Characteristics						
Gate charge	Q_{ge}	$I_C = 57\text{A}$, $V_{CE} = 600\text{V}$, $V_{GE} = +15\text{V}$	-	611	-	nC
Input capacitance	C_{iss}	$V_{CE} = 25\text{V}$,	-	4.29	-	nF
Output capacitance	C_{oss}	$V_{GE} = 0\text{V}$,	-	0.30	-	

Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$	-	0.20	-	
Short circuit current	I_{sc}	$T_C=125^\circ\text{C}$, $V_{CC}=900\text{V}$, $V_{GE}=15\text{V}$, $t_{psc}\leq 10\mu\text{s}$, $V_{CEM}\leq 1200\text{V}$	-	270	-	A

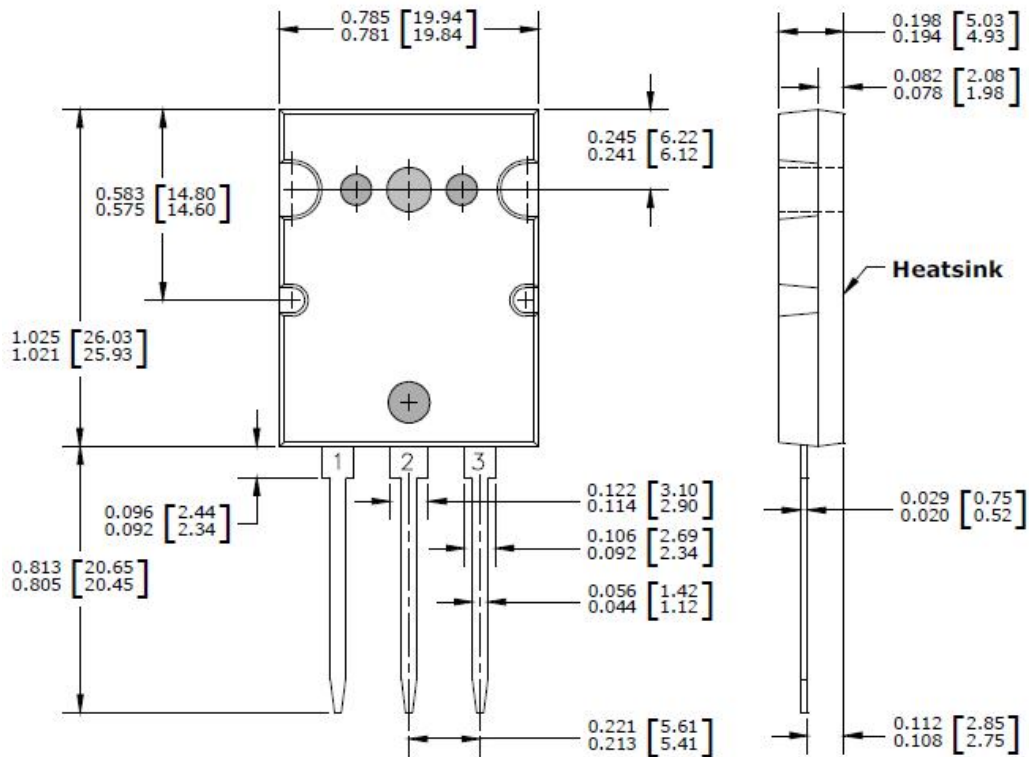
SWITCHING CHARACTERISTICS, Inductive Load, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
IGBT Characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{CC}=600\text{V}$, $I_C=57\text{A}$, $V_{GE}=\pm 15\text{V}$, $R_G=18.2\Omega$	-	421	-	ns
Rise time	t_r		-	150	-	
Turn-off delay time	$t_{d(off)}$		-	428	-	
Fall time	t_f		-	62	-	
Turn-on energy	E_{on}		-	10.2	-	mJ
Turn-off energy	E_{off}	-	2.8	-		

Anti-Parallel Diode Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Diode reverse recovery time	t_{rr}	$V_R=600\text{V}$, $I_F=50\text{A}$ $di_F/dt = 1200\text{A}/\mu\text{s}$	-	190	-	ns
Diode reverse recovery charge	Q_{rr}		-	7.5	-	μC
Diode peak reverse recovery current	I_{rrm}		-	55	-	A

Package Outline Drawing



CAUTION: These devices are ESD sensitive. Use proper handling procedure.

Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**